


14461 U.S. PTO
010204

PATENT APPLICATION
Docket No. 9903-074
Client No. S03US003

16018 U.S. PTO
10/750979
010204

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

EXPRESS MAIL	MAILING LABEL NO. <u>EL982130843US</u> DATE OF DEPOSIT: <u>JANUARY 2, 2004</u>
I HEREBY CERTIFY THAT THIS PAPER AND ENCLOSURES AND/OR FEE ARE BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE "EXPRESS MAIL POST OFFICE TO ADDRESSEE" SERVICE UNDER 37 CFR 1.10 ON THE DATE INDICATED ABOVE AND IS ADDRESSED TO: MAIL STOP PATENT APPLICATION, COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450.	
<u>HILLARY A. DIXON</u> (SENDER'S PRINTED NAME)	 (SIGNATURE)

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventor(s): Dong-Ho Lee

For: STACK PACKAGE MADE OF CHIP SCALE PACKAGES

Applicant requests FIG. 4 to be published with the application.

Enclosures:

- ☒ Specification (pages 1-6); claims (pages 7-10); abstract (page 11)
 - ☒ THREE sheet(s) of FORMAL drawings (comprising 6 figures)
 - ☒ Combined Declaration and Power of Attorney (unsigned)
 - ☐ Assignment with cover sheet
- Assignee Name and Address: Samsung Electronics Co., Ltd.
Suwon-city, Kyungki-do Republic of Korea
- ☒ PTO 1449 Information Disclosure Statement with 6 cited references

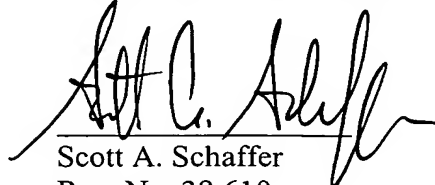
CLAIMS AS FILED				
For	Number Filed	Number Extra	Rate	Basic Fee \$770
Total Claims	20-20	0	x \$ 18 =	\$0.00
Independent Claims	2-3	0	x \$ 86 =	\$0.00
TOTAL FILING FEE				\$770.00

- ☒ Certified copy of Korean Priority Document No. 2003-0281, filed January 3, 2003,
from which priority is claimed.
- ☒ Return Postcard

Customer No. 20575

Respectfully submitted,

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